



ESD SMD Comm COG, Ceramic, 3,300 pF, 20%, 250 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 1206, 1.5 mm



General Information		
Series	ESD SMD Comm COG	
Style	SMD Chip	
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I	
Features	Temperature Stable, Low ESR, Class I	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
AEC-Q200	No	
Typical Component Weight	15 mg	
Shelf Life	78 Weeks	
MSL	1	

3,300 pF

0% Loss/Decade Hour

100 GOhms

1206
3.3mm +/-0.4mm
1.6mm +/-0.35mm
0.78mm +/-0.20mm
1.5mm MIN
0.6mm +/-0.25mm

3.3mm +/-0.4mm	Measurement Condition	1 kHz 1.0Vrms
1.6mm +/-0.35mm	Tolerance	20%
0.78mm +/-0.20mm	Voltage DC	250 VDC
1.5mm MIN	ESD Level per AEC-Q200	16,000 V ESD Level
0.6mm +/-0.25mm	Dielectric Withstanding Voltage	625 VDC
	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
Bulk, Bag	Capacitance Change with	30 ppm/C, 1kHz 1.0Vrms
1	Reference to +25°C and 0 VDC Applied (TCC)	
	Dissipation Factor	0.1% 1 kHz 1.0Vrms

Aging Rate

Insulation Resistance

Specifications Capacitance

Packaging Specifications		
Packaging	Bulk, Bag	
Packaging Quantity	1	

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